ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	PC. Bannockl	ourn, Illinois, A	ll rights reserved untions.	under both	This docum level parts, t	ent is a declarati he declaration e	on of the su	ibstances v s all lower	within the manufacture level materials for w	urer listed which the	item. Note: manufacture	if the item is an as er has engineering	sembly with low responsibility.	
IPC Web Site for Information on IPC-1752 Standard Fo				Form Type Distribute					rials and N	ials and Mfg Information				
Supplier Information														
Company name* Com			Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi									2024-04-23					
Contact Name	tact Name Title - Contact				Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product Enviro			ro Compliance		NA				Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represent			entative		Phone - Representative*			Email	Email - Representative*					
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	e Version Manufacturing Site			Weight*	UOM	Unit Type		
	NCP111	NCP1117LPST33T3G LOW DROPOUT R		Г REGULATOF	RS	2024-04-23 MY		IY1		109.99	mg	Each		
Ianufacturing Proccess Informa	tion													
Terminal Plating / Grid Array M	aterial	tial Terminal Base Alloy		J-STD-020 MSI	L Rating	Peak Proc	Process Body Temperature Max Time at Peal		k Tempera	ature Num	nber of Reflow Cyc	les		
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	seco	nds 3				
omments														
vel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl ohthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ess of the applicable quantity limit identified above may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union membe we independently verified such information. How heir contributions to the part, and those certificat anditions of that agreement, including any warra	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	Bis(2-ethylhexyl) phthalae (DEHP), Benzyl-butyl rt identified on this form contains lead, mercury, tified above. If a homogeneous material within the part with lower level components, the declaration shall s true and correct to the best of its knowledge and belief, a member state laws that implement the RoHS Directive. tion. However, in situations where Supplier has not certifications are at least as comprehensive as the any warranty rights and/or remedies provided as part of m. In the absence of such written agreement, the						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	h. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	3.3	mg	Supplier	Silicon (Si)	7440-21-3		3.3	mg	
Die Attach	2.37	mg	Supplier	Silver (Ag)	7440-22-4		1.7775	mg	
			Supplier	Epoxy resins	129915-35-1		0.5925	mg	
Lead Frame	37.17	mg	Supplier	Silver (Ag)	7440-22-4		0.4832	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.0372	mg	
			Supplier	Iron (Fe)	7439-89-6		0.8921	mg	
			Supplier	Copper (Cu)	7440-50-8		35.7575	mg	
Mold Compound-Black	59.7	mg		Epoxy resin	proprietary data		2.985	mg	
			Supplier	Phenolic Resin	Proprietary Data		2.985	mg	
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.194	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.2985	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		52.2375	mg	
Plating	7.44	mg	Supplier	Tin (Sn)	7440-31-5		7.44	mg	
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg	

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3